

CESION

Yo, (nosotros) abajo firmado (s)

(1) Yuichi KAJITA

(2) Satoshi MIKAMI

(3) Yuhei MIYANO HANA

(4) Tatsuki KOIKE

(5) Masaki DAINI

(6) Norio OYABU

(7) Masaki OGINO

(8) Kohei TAKEUCHI

(9) Yoshiteru ITO

(10) Norihito TOKUNAGA

(11) Takahiro SUGIMOTO

(12) Tohru MIYAZAKI

(13) Tsuneo ODA

(14) Yasutaka HOASHI

(15) Yasushi HATTORI

(16) Keisuke IMAMURA

domiciliado(s) en

declaro(amos) bajo juramento ser único(s) y verdadero(s)
inventor(es) de la invención:declaro(amos) así mismo que cedo(emos) y transfiero(erimos), sin
limitación, a favor de la sociedad**TAKEDA PHARMACEUTICAL COMPANY LIMITED**

constituida y existente de conformidad con las leyes de

Japón

domiciliada en

1-1, Doshomachi 4-chome, Chuo-ku,
Osaka-shi, Osaka 541-0045 Japón**ASSIGNMENT**

I (we), the undersigned

(1) Yuichi KAJITA

(2) Satoshi MIKAMI

(3) Yuhei MIYANO HANA

(4) Tatsuki KOIKE

(5) Masaki DAINI

(6) Norio OYABU

(7) Masaki OGINO

(8) Kohei TAKEUCHI

(9) Yoshiteru ITO

(10) Norihito TOKUNAGA

(11) Takahiro SUGIMOTO

(12) Tohru MIYAZAKI

(13) Tsuneo ODA

(14) Yasutaka HOASHI

(15) Yasushi HATTORI

(16) Keisuke IMAMURA

(1) to (6), and (8) to (16) of

c/o TAKEDA PHARMACEUTICAL COMPANY LIMITED,
26-1, Muraoka-Higashi 2-chome, Fujisawa-shi,

Kanagawa 251-0012 Japan

(7) of

c/o SCOHIA PHARMA, INC.,
26-1, Muraoka-Higashi 2-chome, Fujisawa-shi, Kanagawa
251-8555 Japan

state(s) under oath to be sole and true inventor(s) of the invention:

HETEROCYCLIC COMPOUND AND USE THEREOF

state as well, that assign, without reservations or limitations in favour of

TAKEDA PHARMACEUTICAL COMPANY LIMITED

a corporation constituted and existing in conformity with the laws of

Japan

domiciled in

1-1, Doshomachi 4-chome, Chuo-ku,
Osaka-shi, Osaka 541-0045 Japan

todos los derechos inherentes a dicha invención y que la citada
Compañía queda facultada para solicitar en su nombre la patente
de invención correspondiente en la República de Colombia.

all rights inherent to said invention and that the above mentioned company
hereby is enabled to apply, in its name, for the corresponding patent
invention, in the Republic of Colombia.

Dado y firmado hoy/Given and signed this April 6, 2020
en/in Kanagawa, Japan

por/by Yuichi KAJITA

Firma/Signature 根田 雄一

Dado y firmado hoy/Given and signed this April 2, 2020
en/in Kanagawa, Japan

por/by Satoshi MIKAMI

Firma/Signature 米沢 聡

Dado y firmado hoy/Given and signed this April 2, 2020
en/in Kanagawa, Japan

por/by Yuhei MIYANOHANA

Firma/Signature 宮野 昇 悠平

Dado y firmado hoy/Given and signed this April 2, 2020
en/in Kanagawa, Japan

por/by Tatsuki KOIKE

Firma/Signature Tatsuki Koike

Dado y firmado hoy/Given and signed this April 19, 2020
en/in _____

por/by Masaki DAINI

Firma/Signature Masaki Daini

Dado y firmado hoy/Given and signed this April 2, 2020
en/in Kanagawa, Japan

por/by Norio OYABU

Firma/Signature

下敷 紀雄

Dado y firmado hoy/Given and signed this _____
en/in _____

por/by Masaki OGINO

Firma/Signature

Dado y firmado hoy/Given and signed this March 2, 2020
en/in Kanagawa, Japan

por/by Kohei TAKEUCHI

Firma/Signature

Kohei Takeuchi

Dado y firmado hoy/Given and signed this March 2, 2020
en/in Kanagawa, Japan

por/by Yoshiteru ITO

Firma/Signature

Yoshiteru Ito

Dado y firmado hoy/Given and signed this March 2, 2020
en/in Kanagawa, Japan

por/by Norihito TOKUNAGA

Firma/Signature

Norihito Tokunaga

Dado y firmado hoy/Given and signed this March 2, 2020
en/in Kanagawa, Japan

por/by Takahiro SUGIMOTO

Firma/Signature Takahiro Sugimoto

Dado y firmado hoy/Given and signed this February 14, 2020
en/in Kanagawa, Japan

por/by Tohru MIYAZAKI

Firma/Signature 宮崎 徹

Dado y firmado hoy/Given and signed this February 17, 2020
en/in Osaka, Japan

por/by Tsuneo ODA

Firma/Signature Tsuneo Oda

Dado y firmado hoy/Given and signed this April 2, 2020
en/in Kanagawa, Japan

por/by Yasutaka HOASHI

Firma/Signature 帆足 保孝

Dado y firmado hoy/Given and signed this March 2, 2020
en/in Kanagawa, Japan

por/by Yasushi HATTORI

Firma/Signature 服部 靖志

Dado y firmado hoy/Given and signed this April 9, 2020
en/in Kanagawa, Japan

por/by Keisuke IMAMURA

Firma/Signature 今村 圭佑